

DATA SHEET

SKY73062-11: 700 – 1000 MHz High Linearity, Single Up/Downconversion Mixer

Applications

- 2G/3G base station transceivers:
 - GSM/EDGE, CDMA, UMTS/WCDMA
- Wi-Fi (802.11)
- WiMAX (802.16)
- 3GPP Long-Term Evolution
- Wireless Local Loop
- High performance radio links
- Land mobile radio
- Private mobile radio

Features

- Operating frequency range: 700 to 1000 MHz
- IF frequency range: 50 to 300 MHz
- Insertion loss: 6.3 dB
- Input IP3: +28.7 dBm
- Noise Figure: 7.2 dB
- Integrated LO driver
- Integrated low loss RF balun
- On-chip SPDT LO switch (greater than 40 dB LO-to-LO isolation)
- Small, MCM (20-pin, 5 x 5 mm) package (MSL3, 260 °C per JEDEC J-STD-020)
- For RoHS and other product compliance information, see the [Skyworks Certificate of Conformance](#)

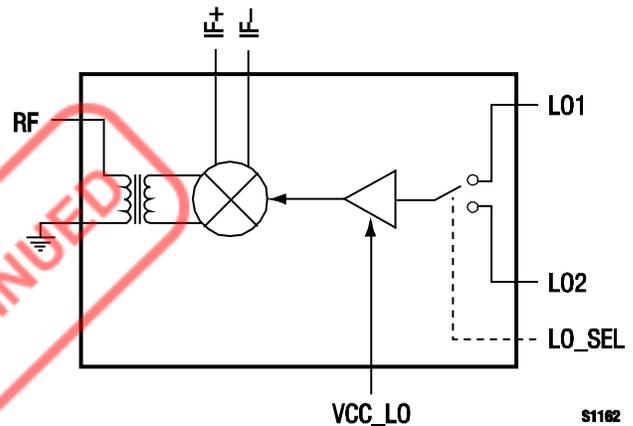


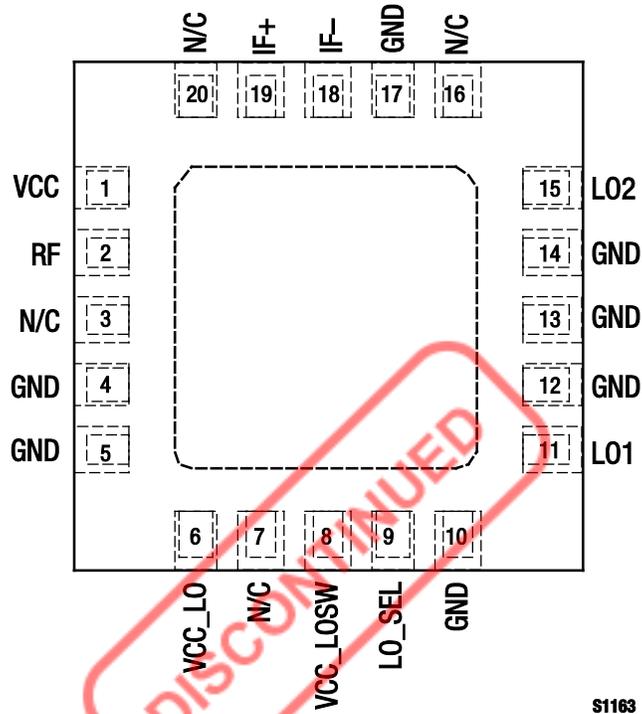
Figure 1. SKY73062-11 Block Diagram

Description

The SKY73062-11 is a fully integrated up/downconversion mixer that includes a Local Oscillator (LO) driver, an LO switch, and a high linearity mixer. A low loss RF balun has also been included to reduce design complications and lower system cost.

The SKY73062-11 features an input IP3 of +28.7 dBm and an insertion loss of 6.3 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 40 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73062-11 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73062-11 single up/downconversion mixer is provided in a compact, 20-pin 5 x 5 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



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Figure 2. SKY73062-11 Pinout – 20-Pin MCM (Top View)

Table 1. SKY73062-11 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	VCC	DC supply, +5V	11	LO1	LO1 input
2	RF	RF input	12	GND	Ground
3	N/C	No connection	13	GND	Ground
4	GND	Ground	14	GND	Ground
5	GND	Ground	15	LO2	LO2 input
6	VCC_LO	LO DC supply, +5V	16	N/C	No connection
7	N/C	No connection	17	GND	Ground
8	VCC_LOSW	LO switch DC supply, +5V	18	IF-	Negative IF output
9	LO_SEL	LO select switch control	19	IF+	Positive IF output
10	GND	Ground	20	N/C	No connection

Functional Description

The SKY73062-11 is a high linearity, single up/downconversion mixer, optimized for base station receiver applications. The device consists of a low loss RF balun and high linearity passive mixer.

An LO amplifier is also included that allow the SKY73062-11 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs (LO1 and LO2) for frequency hopping applications such as GSM.

RF Balun and Passive Mixer

The RF balun provides a single ended input, which can easily be matched to 50 Ω using a simple external matching circuit. The balun offers very low loss, and excellent amplitude and phase balance.

The high linearity SKY73062-11 is a passive, double-balanced mixer that provides a very low conversion loss, and excellent 3rd Order Input Insertion Point (IIP3).

Additionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffer and SPDT LO Switch

The LO buffer allows the input power of the SKY73062-11 to be in the range of ±6 dBm. The LO section is optimized for high-side LO injection. However, each of the two LOs can be driven over a wide frequency range with some degradation in performance.

A high isolation SPDT switch allows the SKY73062-11 to be used for frequency hopping applications. This switch provides greater than 40 dB of LO1 to LO2 isolation:

LO_SEL Input	LO Path Selected
High	LO1 (pin 11) enabled
Low	LO2 (pin 15) enabled

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used. An internal pull-down resistor enables the LO2 input.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73062-11 are provided in Table 2 and the recommended operating conditions in Table 3. Electrical characteristics for the SKY73062-11 are provided in Table 4.

Table 2. SKY73062-11 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage, +5 V	VCC	4.5	5.5	V
Supply current	I _{CC}		100	mA
RF input power	P _{RF}		+20	dBm
IF input power	P _{IF}		+20	dBm
LO input power	P _{LO}		+20	dBm
Operating case temperature	T _C	-40	+85	°C
Junction temperature	T _J		+150	°C
Storage case temperature	T _{STG}	-40	+125	°C

Notes: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SKY73062-11 Recommended Operating Conditions

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage, +5 V	VCC	4.75	5.00	5.25	V
Supply current	I _{CC}		70		mA
LO input power	P _{LO}	-6	0	+6	dBm
LO select input: high low	LO_SEL _H LO_SEL _L	2.2		0.8	V V
Operating case temperature	T _C	-40		+85	°C
RF frequency range	F _{RF}	700		1000	MHz
LO frequency range (Note 1)	F _{LO}	900		1200	MHz
IF frequency range	F _{IF}	50		300	MHz

Note 1: The SKY73062-11 has been optimized for high-side LO injection. However, the LO can be used outside of the specified frequency range with degraded performance.

Table 4. SKY73062-11 Electrical Specifications (Note 1) (1 of 2)

(Voltage Supply = +5 V, T_C = +25 °C, LO = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 200 MHz, LO Frequency = 1100 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Downconversion insertion loss	I _{LDOWN}	RF input to IF output, F _{RF} = 900 MHz, P _{RF} = 0 dBm		6.3	7.5	dB
Upconversion insertion loss	I _{LUP}	IF input to RF output, F _{IF} = 200 MHz, P _{IF} = 0 dBm		6.2	7.5	dB
Noise Figure	NF			7.2	10.0	dB
Noise Figure with a blocker signal (Note 2)	NF _{BLK}	Blocking signal input power = +8 dBm			25	dB
Downconversion third order input intercept point	IIP3 _{DOWN}	RF input, F _{RF} = 900 MHz and 900.8 MHz, P _{RF} = 0 dBm/each tone	+26.0	+28.7		dBm
Upconversion third order input intercept point	IIP3 _{UP}	IF input, F _{IF} = 200 MHz and 200.8 MHz, P _{IF} = 0 dBm/each tone	+23.0	+25.8		dBm
2RF – 2LO	2x2	Downconversion, P _{RF} = -10 dBm		-60	-50	dBc
3RF – 3LO	3x3	Downconversion, P _{RF} = -10 dBm		-79.9	-65.0	dBc
Input 1 dB compression point	IP1dB	Downconversion	+16.0	+18.3		dBm
LO1-to-LO2 isolation			30	45		dB
RF to IF isolation			30.0	43.5		dB
LO leakage: @ RF port @ IF port				-30.9 -34.9	-25.0 -30.0	dBm dBm
LO_SEL input (Note 2)			-20	+150	+250	μA
LO switching time (Note 2)					0.5	μs

Table 4. SKY73062-11 Electrical Specifications (Note 1) (2 of 2)

(Voltage Supply = +5 V, T_c = +25 °C, LO = 0 dBm, RF Frequency = 900 MHz, IF Frequency = 200 MHz, LO Frequency = 1100 MHz, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF port input return loss	Z _{IN_RF}	With external matching components	14			dB
LO port input return loss	Z _{IN_LO}	With external matching components	14			dB
IF port input return loss	Z _{OUT_IF}	With external matching components	14			dB

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Note 2: Specification guaranteed by design. Not tested in production.

Evaluation Board Description

The SKY73062-11 Evaluation Board is used to test the performance of the SKY73062-11 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 3 and the layer detail is provided in Figure 4.

Circuit Design Configurations

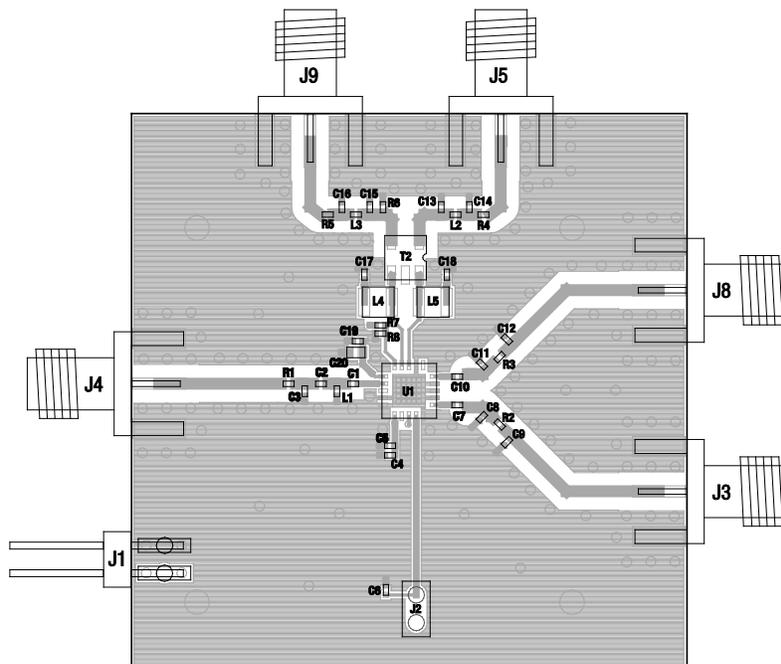
The following design considerations are general in nature and must be followed regardless of final use or configuration:

1. Paths to ground should be made as short and as low impedance as possible.

2. The ground pad of the SKY73062-11 provides critical electrical and thermal functionality. The connection to the ground pad should be designed to provide the best ground for the mixer. For more information on soldering the SKY73062-11, refer to the Package and Handling Information section of this Data Sheet.

3. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device.

A schematic diagram for the SKY73062-11 Evaluation Board is shown in Figure 5.



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Figure 3. SKY73062-11 Evaluation Board Assembly Diagram

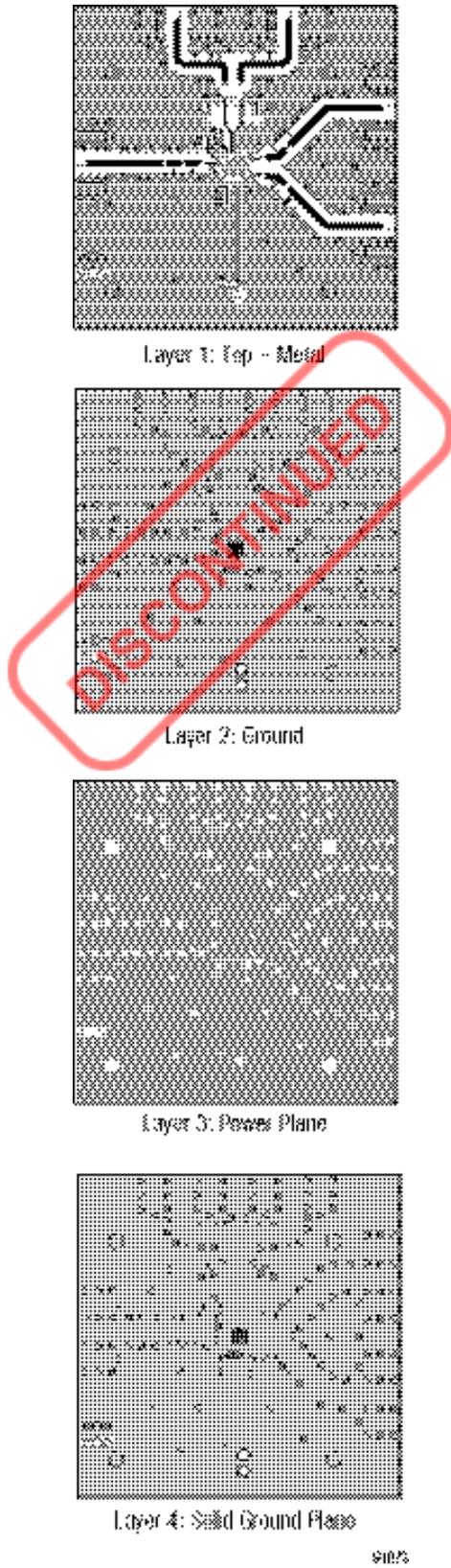
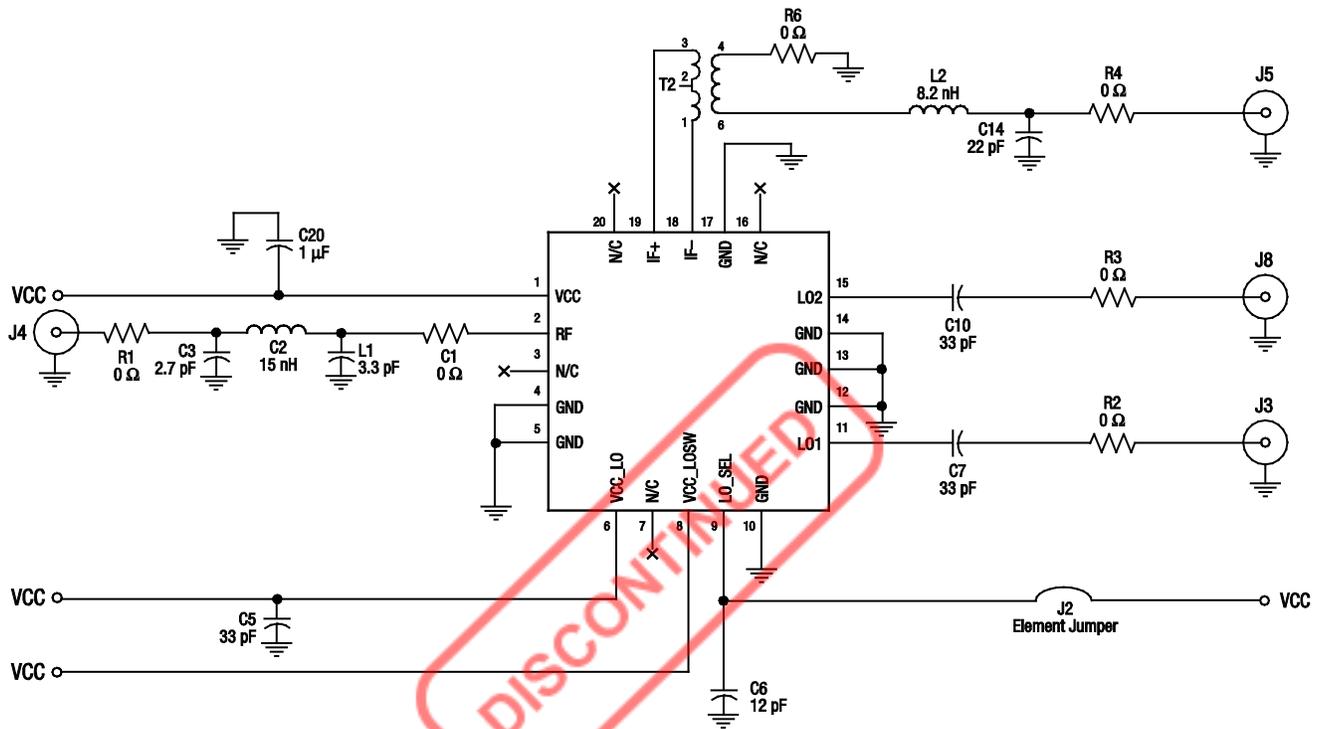


Figure 4. SKY73062-11 Evaluation Board Layer Detail



Notes: Values for all components are subject to change for matching purposes.

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Figure 5. SKY73062-11 Evaluation Board Schematic

Package Dimensions

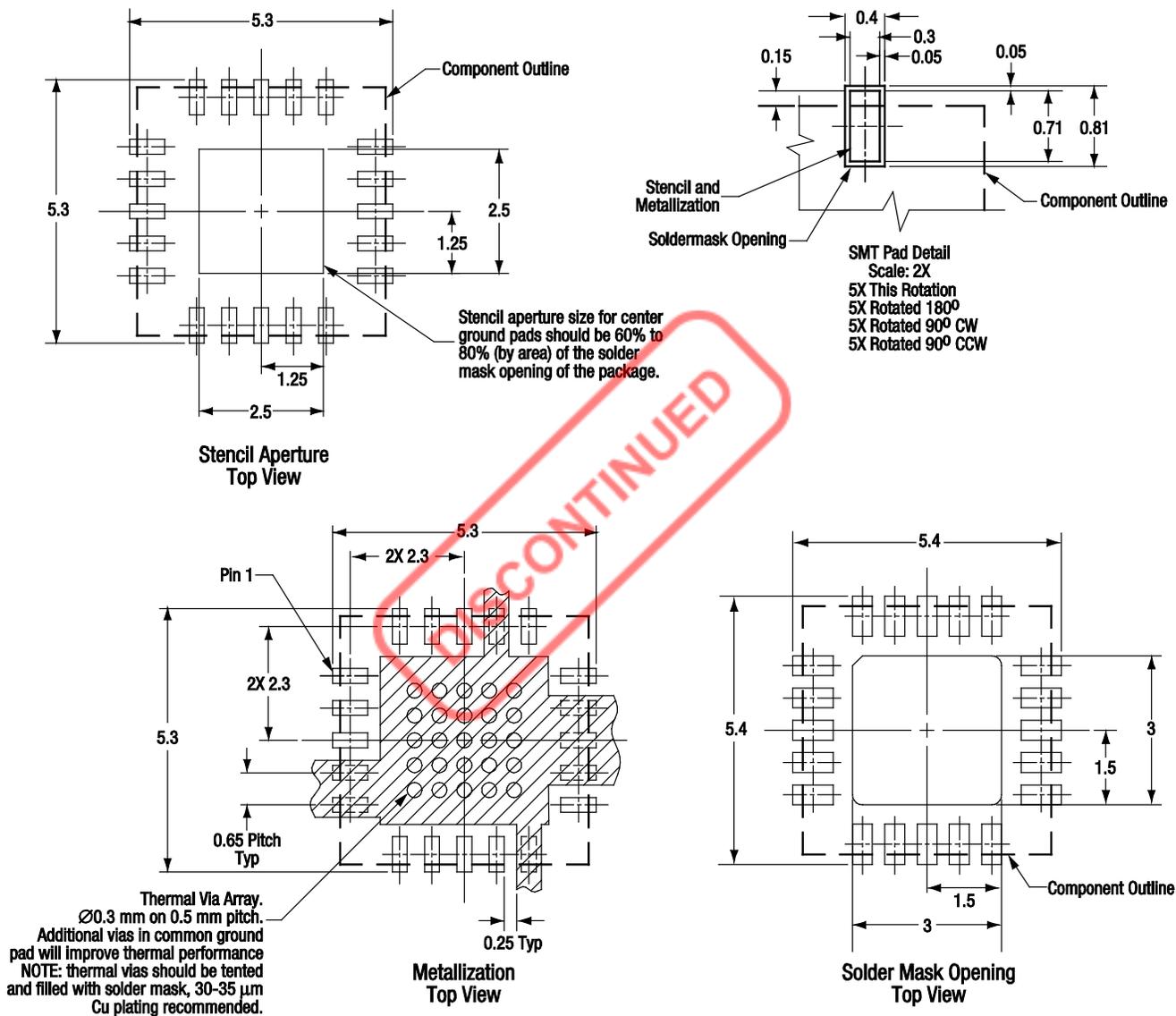
The PCB layout footprint for the SKY73062-11 is provided in Figure 6. Package dimensions for the 20-pin MCM are shown in Figure 7, and Figure 8 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY73062-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

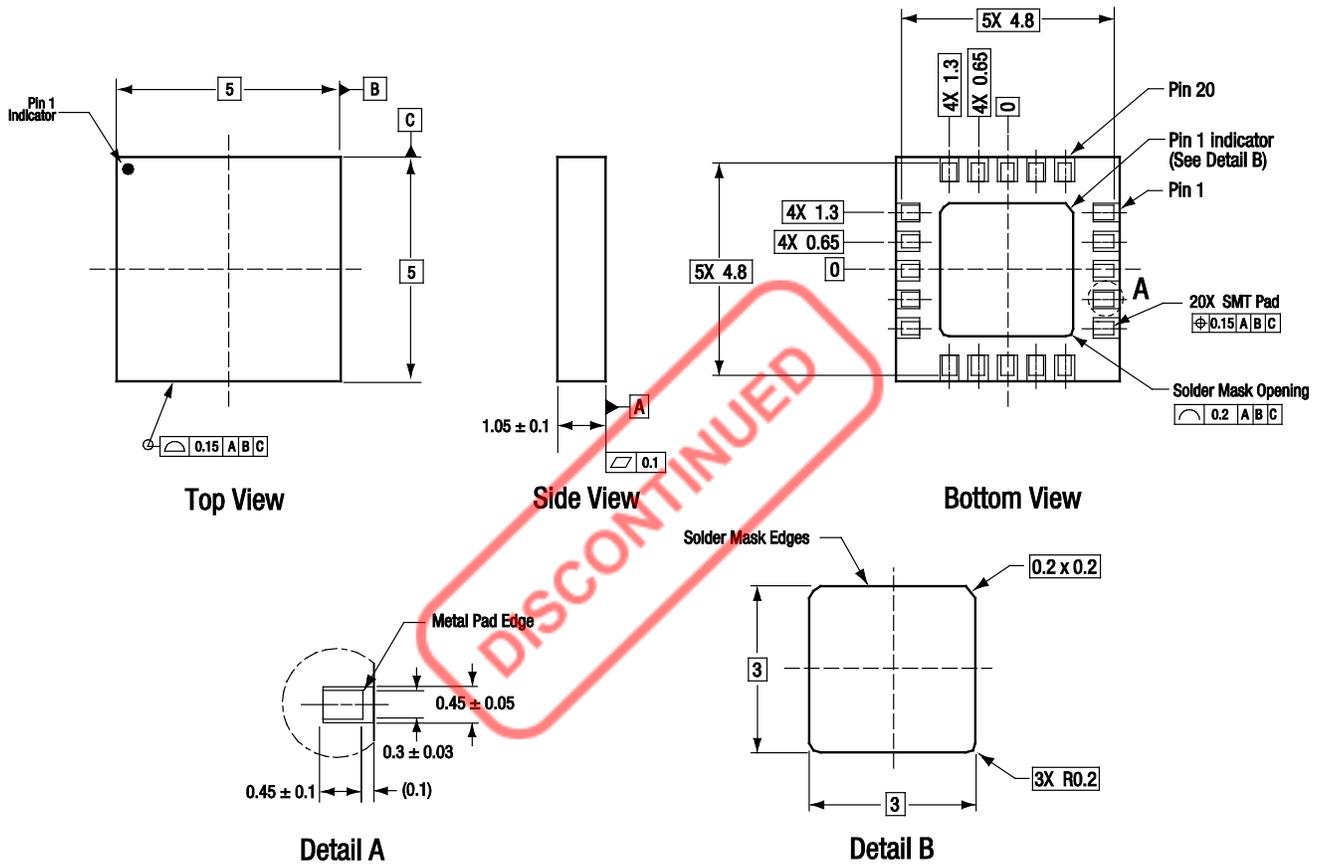


All measurements are in millimeters

Note: The cross-hatched area represents the merger of the center ground pad + 7 individual I/O ground pads. All I/O ground pads should have at least one via connected to internal ground planes for optimum electrical performance.

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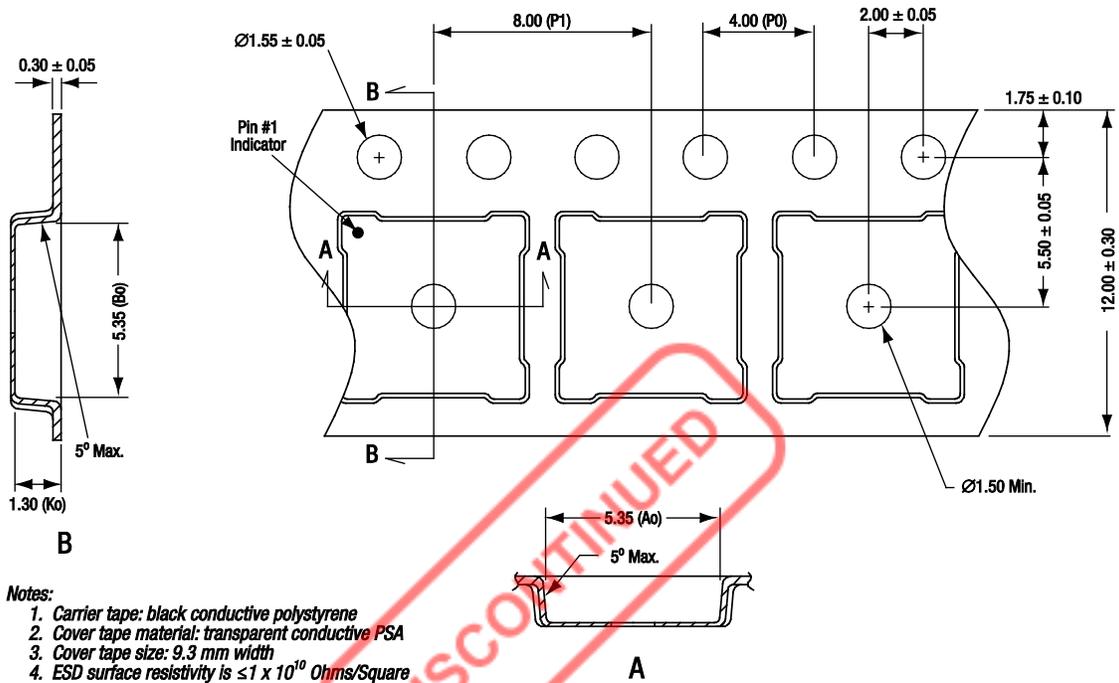
Figure 6. SKY73062-11 PCB Layout Footprint



All measurements are in millimeters.
Dimensioning and tolerancing according to ASME Y14.5M-1994.

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Figure 7. SKY73062-11 20-Pin MCM Package Dimensions



- Notes:**
1. Carrier tape: black conductive polystyrene
 2. Cover tape material: transparent conductive PSA
 3. Cover tape size: 9.3 mm width
 4. ESD surface resistivity is $\leq 1 \times 10^{10}$ Ohms/Square according to EIA, JEDIC TNR specification.
 5. P_0/P_1 , 10 pitches cumulative tolerance on tape: ± 0.20 mm
 6. A and B measurement points are 0.30 mm from bottom pocket.
 7. All dimensions are in millimeters

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Figure 8. SKY73062-11 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY73062-11 700-1000 MHz Up/Downconversion Mixer	SKY73062-11	TW18-D470



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